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PTO/SB/21 (08-03)
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U.S. Patent and Trademark Office; U.S. DEPARTMENT OF COMMERCE are required to respond ollection of information unless it displays a valid OMB control number Application Number 10/708,207 **TRANSMITTAL** Filing Date 02/17/2004 **FORM** First Named Inventor Chia-Chang Lee Art Unit (to be used for all correspondence after initial filing) Examiner Name Attorney Docket Number YOIP0003USA Total Number of Pages in This Submission **ENCLOSURES** (Check all that apply) After Allowance communication Fee Transmittal Form Drawing(s) to Technology Center (TC) Appeal Communication to Board Licensing-related Papers Fee Attached of Appeals and Interferences Appeal Communication to TC Petition Amendment/Reply (Appeal Notice, Brief, Reply Brief) Petition to Convert to a Proprietary Information After Final **Provisional Application** Power of Attorney, Revocation Status Letter Affidavits/declaration(s) Change of Correspondence Address Other Enclosure(s) (please Terminal Disclaimer Extension of Time Request Identify below): Request for Refund Express Abandonment Request CD, Number of CD(s) Information Disclosure Statement Remarks Certified Copy of Priority Document(s) Response to Missing Parts/ Response to the office action has been sent to the examiner by fax on 12/04/2003 Incomplete Application Response to Missing Parts under 37 CFR 1.52 or 1.53 SIGNATURE OF APPLICANT, ATTORNEY, OR AGENT Firm Winston Hsu, Reg. No.: 41,526 Individual name Signature Date CERTIFICATE OF TRANSMISSION/MAILING I hereby certify that this correspondence is being facsimile transmitted to the USPTO or deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450 on the date shown below. Typed or printed name

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PTO/SB/17 (10-03)

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# FEE TRANSMITTAL for FY 2004

Effective 10/01/2003. Patent fees are subject to annual revision.

Applicant claims small entity status. See 37 CFR 1.27

TOTAL AMOUNT OF PAYMENT

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Co	omplete if Known
Application Number	10/708,207
Filing Date	02/17/2004
First Named Inventor	Chia-Chang Lee
Examiner Name	
Art Unit	
Attorney Docket No.	YOIP0003USA

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1204 86	2204 43		nt claims					examined (37 CFR 1.129(b))	<del></del>
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1205 18	2205 9	** Reissue claims in ea and over original par		1802	900	1802	900	<ul> <li>Request for expedited examination of a design application</li> </ul>	
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SUBMITTED BY	-	_				(Complete	(if applica	able))	
Name (Print/Type)	Winston Hsu	/-	1	Registration No.	41,526	Telephone	9 88628	39237350	
Signature		1	lin	lan Har	4	Date	13/	12120	00

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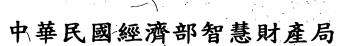
# **DECLARATION** — Supplemental Priority Data Sheet

Additional foreign app	lications:			
Prior Foreign Application Number(s)	Country	Foreign Filing Date (MM/DD/YYYY)	Priority Not Claimed	Certified Copy Attached? YES NO
092203137	Taiwan R.O.C	02/24/2003		
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INTELLECTUAL PROPERTY OFFICE MINISTRY OF ECONOMIC AFFAIRS REPUBLIC OF CHINA

兹證明所附文件,係本局存檔中原申請案的副本,正確無訛。

其申請資料如下

인 리터 리드 리드

This is to certify that annexed is a true copy from the records of this office of the application as originally filed which is identified hereunder:

申 請 日 : 西元 <u>2003</u> 年 <u>02</u> 月 <u>24</u> 日 Application Date

申 請 案 號 : 092203137 Application No.

申 請 人: 揚明光學股份有限公司 Applicant(s)/

局

長

Director General



發文日期: 西元 2004 年 2 月 10 日

Issue Date

發文字號: 09320122070

Serial No.



(以上各欄	由本局填	新型專利說明書
_	中文	積分柱承托裝置
新型名稱	英文	Holding apparatus for a rod
	姓 名 (中文)	1. 李嘉樟 2. 蔡智偉 3. 張景昇
=	(英文)	1.Lee Chia Chang 2.Tsai Chih Wei 3.Chang Ching Sheng
創作人 (共3人)	國 籍 (中英文)	1. 中華民國 TW 2. 中華民國 TW 3. 中華民國 TW
	住居所 (中 文)	<ol> <li>新竹科學工業園區新竹市力行路11號</li> <li>新竹科學工業園區新竹市力行路11號</li> <li>新竹科學工業園區新竹市力行路11號</li> </ol>
	住居所 (英 文)	1. No 11, Li Hsing Rd, Science-Based Industrial Park, Hsinchu, R.O.C. 2. No 11, Li Hsing Rd, Science-Based Industrial Park, Hsinchu, R.O.C. 3. No 11, Li Hsing Rd, Science-Based Industrial Park, Hsinchu, R.O.C.
	名稱或 姓 名 (中文)	1. 揚明光學股份有限公司
	名稱或 姓 名 (英文)	1. Young Optics Inc.
Ξ,	國 籍 (中英文)	1. 中華民國
申請人(共1人)	住居所 (營業所) (中 文)	1. 新竹科學工業園區新竹市力行路11號 (本地址與前向貴局申請者相同)
	(營業所) (英 文)	1. No 11, Li Hsing Rd, Science-Based Industrial Park, Hsinchu, Taiwan, R.O.C.
	代表人(中文)	1. 莊謙信
	代表人 (英文)	1. Frank Chuang
		MRE (FUSS) CONTROL FRENCH STANTON OF MILLION



#### 四、中文創作摘要 (創作名稱:積分柱承托裝置)

# 陸、英文創作摘要 (創作名稱:Holding apparatus for a rod)

The holding apparatus is disposed outside of a rod, and comprises a holder having a heat sink substrate with fins to be provided with the large heat exchange area. The space between the holder and rod is filled with thermal conductivity substances to reduce the heat contact resistance. The heat of rod is conducted to the holder by the conductivity substances, and then the heat of holder is taken out by natural or forced convection. Thus it can enhance the cooling efficiency and reduce the heat contact





四、中文創作摘要 (創作名稱:積分柱承托裝置) 陸、英文創作摘要 (創作名稱: Holding apparatus for a rod) resistance.

四、中文創作摘要 (創作名稱:積分柱承托裝置)

伍、(一)、本案代表圖為: 第\_\_\_2\_\_ 圖

(二)、本案代表圖之元件代表符號簡單說明:

積分柱承托裝置 10 1 1 承托件 散熱基板 1 1 1 1 1 2 散熱鰭片 第一填膠孔 1 1 3 第二填膠孔 1 1 4 導熱物質 1 2 1 3 熱 管 蒸發端 1 3 1 1 3 2 冷凝端

陸、英文創作摘要 (創作名稱: Holding apparatus for a rod)



四、中文創作摘要 (創作名稱:積分柱承托裝置)

散熱裝置

1 4

積分柱

2 0

陸、英文創作摘要 (創作名稱:Holding apparatus for a rod)



- 1		~		
	一、本案已向			
	國家(地區)申請專利	申請日期	案 號	主張專利法第一百零五條準用 第二十四條第一項優先權
				7 - 1 - 1 M A
	二、□主張專利法第一百	零五條準用第二十	五條之一第一項	<b>〔優先權:</b>
	申請案號:			
	日期:			
	三、主張本案係符合專利	法第九十八條第一	項□第一款但書	<b>;或□第二款但書規定之期間</b>
	日期:			
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## 五、創作說明(1)

【新型所屬之技術領域】

本創作係有關積分柱,尤其係指一種可承托積分柱及強化散熱效果之積分柱承托裝置。

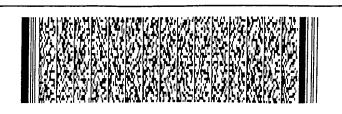
## 【先前技術】

請參閱第1圖所示,習知積分柱1(Optical integration rod )係利用玻璃基板相互搭接並黏著而形成一中空柱狀,並於積分柱1內壁鍍有反射膜,使進入積分柱1之光東可經反射膜作多次反射,達到均勻光東:而積分柱1裝設於光學系統內需搭配承托件2以防止破壞結構及達到光學定位要求,且系統需具有散機制來移除強烈光東累積於積分柱1之熱能,使積分柱1維持最佳光學工作溫度。

習知積分柱1採用之承托件2係為一中空柱狀之飯。 金件,包覆於積分柱1外側,並藉固定外線(Ultra 金件,包覆於積分柱1外側,並藉固定分柱1期間 及夾具裝置固定積分柱1點學路徑位置。而為整 及夾具裝置固定積分柱1於過程中受力,一般承托件2表面 開孔3,以減少承托件2與積分柱1之接觸面積, 開孔3,以減少承托件2與積分柱1之接觸面時 作為UV固化膠之注入孔,而且藉由開孔3並搭配系統 自然對流,或設置一風扇直接吹向積分柱1之熱量,來達到散熱目的。

習知積分柱 1 散熱雖利用空氣作為傳導媒介導出積分柱 1 之熱量,但由於空氣之傳導係數較固體低故接觸熱阻高,使得散熱效率較差;因此為了增加散熱效率或





## 五、創作說明 (2)

熱量無法有效排出時,係採用強制對流方式,即增設風扇加強對流,但風扇轉動會產生噪音,干擾觀賞環境,且積分柱1為玻璃材質其傳導係數低,故風扇直接對積分柱1散熱,其帶走之熱量有限;因此,利用習知之開孔3或增設風扇產生強制對流之方式,均無法有效達到散熱。

# 【新型內容】

本創作之一目的,係提供一種積分柱承托裝置,利用外表面具有散熱功能設計之承托件,及注入導熱物質於積分柱與承托件間以降低接觸熱阻,使積分柱熱量能夠有效地經由導熱物質、承托件而散逸至冷卻流體,進而提高散熱效率。

本創作之另一目的,係提供一種積分柱承托裝置,可使相同尺寸之承托件適用於各種尺寸之積分柱,以提高使用彈性,降低零件成本。

本創作之又一目的,係提供一種積分柱承托裝置,可利用熱管之設置,將積分柱之熱量傳送至較佳之自然對流或強制對流的位置,以增強散熱效果。

為達上述目的,本創作之積分柱承托裝置係設置於一積分柱外側,其包括一外表面具有鰭片結構之承托件,該承托件可為散基板,且承托件與積分柱間之間隙填充有導熱物質,積分柱之熱量可藉由導熱物質導出後,傳導至承托件再利用自然對流或強制對流方式將熱量帶走而達到散熱;另外可增設熱管一端連接於承托件,





#### 五、創作說明(3)

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另一端連接散熱裝置,藉由熱管的特性可將積分柱之熱量傳送至較佳之自然對流或強制對流的位置以達到散熱要求。

## 【實施方式】

有關本創作為達到上述目的,所採用之技術手段及其餘功效,茲舉下列較佳實施例,並配合圖式加以說明如下:

2 圖所示,本創作之積分柱承托裝置 其包括一承托件 ] 1 ,承托件11條設置於一積分柱 且該承托件1 1 與積分柱20間充填有 () 外側, ] 之形狀可依空間及積分柱2 ;該承托件] 本實施例配合積分柱20而設為一中 空柱體 中空部分供積分柱20容置 ,該承托件1 1 由 1 1及複數個鰭片1 1 2所組成 ,該散熱 製成 係由高熱傳導係數材質 銅 等 如 鋁 2 1 兩 表 面 外 側 設 有 鰭 片 1 1 且鰭 1 2 間設有平面 1 1 1 以利調整裝置或夾具夾持抵

2 然 鰭 片 1 7 可設置於散熱基板 1 1 1 之至 片 1 1 2之位置 、 數 量 與 大 小 係 可 依 據 及流道設計 適當配置 如自然對流佳之區 而 作 片 1 1 2 以增加熱交換面積及熱傳導 2 1 1 之四 1 1 亦可設置於散熱基板 1 (如第 所 示 ) 圖所示 側 面 4 圖 或由散熱基板 ]一端延伸形成 (如第5圖所示)





#### 五、創作說明 (4)

該承托件 1 1 之表 圖 面 開 設 有 至 及 孔 1 1 4 使 較 黏 性 3 ) 第 固 可 由 填 孔 1 注入 2 0 黏 著 固 柱 定 而 筝 ) · 可 由 第 填膠 孔 1 4 注 2 鲢 承托件 1 1 間之間 隙 內 因 此 柱 1 可使相同 寸之承托件可 填充 尺 適 提高使用 彈 降低 而 性 成 同 柱 又可 降低接觸 埶 阻並增 加 效果

2 可透過 導 埶 物 質 1 俥 至承托 0 之 量 2 糸 再 由 統內之 自 1 之熱 量 達到散熱 由於本創作係 由 分柱 2 導 出 至承托 0 之熱 量 件 1 羽 其 導效果 較 知之流體作 為 分柱 2 將 0 散 埶 埶 而 1 1 大之承托 件 再進行 散 因 可 另 外 亦可以配合強制對流方式增 率 換現 提 高 散熱效果 而

示 係將本創作 藇 習 壆 光 糸 統內 百 並於 積 中 口設 置 Α В C之温度 量 測點 測試數據例如 溫度 量測 後 進行 2 外侧有加裝一驅 壓 為8 V 之 風 0 動 本創作於量測點A與B溫度約可降低2





#### 五、創作說明 (5)

測點C溫度約可降低 3 8 ℃;而當積分柱 2 0 外側無加裝風扇狀態下,本創作於量測點A與B溫度約可降低 6 5 ℃,量測點C溫度約可降低 1 0 6 ℃;由實驗數據可知,採用本創作之積分柱承托裝置,可大大降低積分柱之溫度,而提供較佳散熱效果。

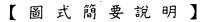
另外,當由於積分柱附近之空間有限或者是由於防塵需求,侷限了冷卻設計空間時,可利用設置熱管(Heat pipe) 1 3 方式,將承托件 1 1 之能量傳送至自然對流較佳或可設置強制對流之位置進行散熱,請參閱第8 圖所示,係將一熱管 1 3 之蒸發端 1 3 1 連接於承托件 1 1 ,冷凝端 1 3 2 連接於一散熱裝置 1 4 ,為一具有鰭片之散熱片或低溫水槽(圖未示)等,藉由熱管 1 3 將承托件 1 1 之熱量傳導至散熱裝置 1 4 ,再進行冷卻來達到散熱目的。{

以上所述,僅用以方便說明本創作之較佳實施例,本創作之範圍不限於該等較佳實施例,凡依本創作所做的任何變更,於不脫離本創作之精神下,皆屬本創作申請專利範圍。





#### 圖式簡單說明



第1圖,係習知積分柱與固定件之組合圖。

第2圖,係本創作第一實施例積分柱承托裝置之結構

圖。

第3圖,係本創作第二實施例積分柱承托裝置之結構

圖。

第4圖,係本創作第三實施例積分柱承托裝置之結構

圖。

第5圖,係本創作第四實施例積分柱承托裝置之結構

圖。

第6圖,係本創作量測點之位置示意圖。

第7圖,係本創作與習知積分柱之溫度比較圖。

第8圖,係本創作採用熱管之積分柱承托裝置結構圖

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# 【圖號簡要說明】

積分柱承托裝置 10

承托件 11

散熱基板 111

散 熱 鰭 片 1 1 2

平面 1121

第一填膠孔 113

第二填膠孔 114

導熱物質 12

熱 管 1 3



# 圖式簡單說明

蒸發端

1 3 1

冷凝端

1 3 2

散熱裝置

1 4

積分柱

2 0

量測點

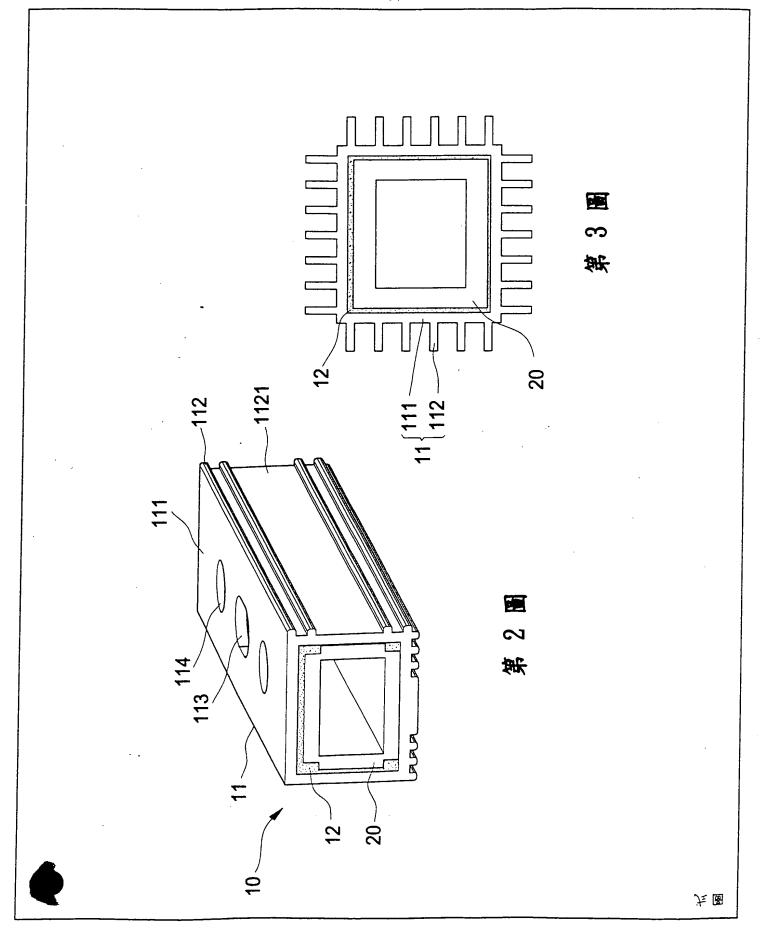
A . B . C

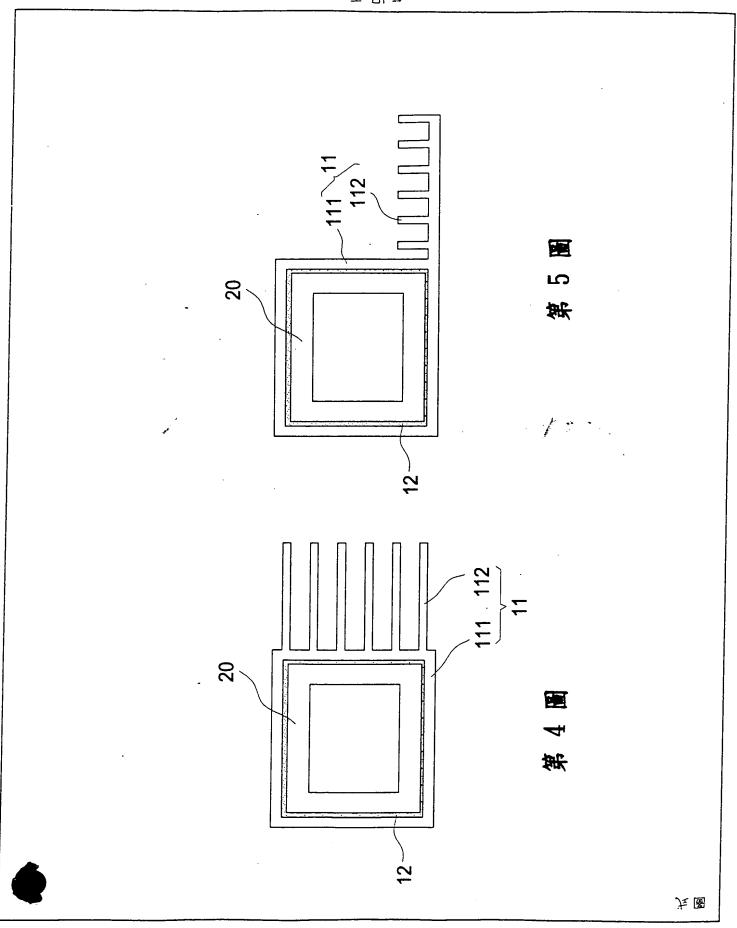


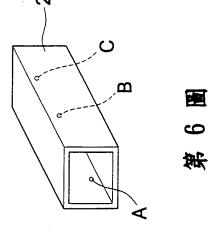
#### 六、申請專利範圍

- 1、一種積分柱承托裝置,其包括
  - 一承托件、係設於該積分柱外側、且該承托件與積分柱間充填有導熱物質。
- 2、如申請專利範圍第1項所述之積分柱承托裝置,其中該承托件為一散熱基板。
- 3、如申請專利範圍第2項所述之積分柱承托裝置,其中該散熱基板係為高熱傳導係數材質。
- 4、如申請專利範圍第2項所述之積分柱承托裝置,其中該散熱基板上設有散熱鰭片。
- 5、如申請專利範圍第4項所述之積分柱承托裝置,其中該散熱鰭片可設於散熱基板之至少一側。
- 6、如申請專利範圍第1項所述之積分柱承托裝置,其中該承托件係為一中空柱體。
- 7、如申請專利範圍第1項所述之積分柱承托裝置,其 中該承托件表面設有至少一填膠孔。
- 8、如申請專利範圍第1項所述之積分柱承托裝置,其中該承托件連接於一熱管之一端,另一端連接一散熱裝置。
- 9、如申請專利範圍第8項所述之積分柱承托裝置,其中該散熱裝置可為一散熱片。









条件	外加風扇	飚	無風	飚
量測位置	、本創作	習和	本創作	習知
٧	103.4°C	128.2°C	128.2°C 147.8°C 213.3°C	213.3°C
В	92.4°C	111.7°C	92.4°C   111.7°C   128.1°C   190.6°C	190.6°C
ပ	88.2°C	126.3°C	88.2°C   126.3°C   151.2°C   258.1°C	258.1°C

頁 81 策

第7圈

